

SML300HB12

Attributes:

- aerospace build standard
- high reliability
- lightweight
- metal matrix base plate
- AlN isolation
- trench gate igbts



Maximum rated values/Electrical Properties

| | | | | |
|-----------------------------------|--------------------------------------|--------------|-------|--------------------|
| Collector-emitter Voltage | | V_{ce} | 1200 | V |
| DC Collector Current | Tc=70C, Tvj=175C Tc=25C, Tvj=175C | $I_{c, nom}$ | 300 | A |
| | | I_c | 440 | |
| Repetitive peak Collector Current | tp=1msec, Tc=80C | I_{crm} | 600 | A |
| Total Power Dissipation | Tc=25C | P_{tot} | 2380 | W |
| Gate-emitter peak voltage | | V_{ges} | +/-20 | V |
| DC Forward Diode Current | | I_f | 300 | A |
| Repetitive Peak Forward Current | tp=1msec | I_{frm} | 600 | A |
| I ² t value per diode | Vr=0V, tp=10msec, Tvj=125C | I_t^2 | 19000 | A ² sec |
| Isolation voltage | RMS, 50Hz, t=1min | V_{isol} | 2500 | V |

| | | | | | | |
|--------------------------------------|-------------------------------------|---------------|-----|------|------|----|
| Collector-emitter saturation voltage | Ic=300A, Vge=15V, Tc=25C | $V_{ce(sat)}$ | | 1.7 | 2.15 | V |
| | Ic=300A, Vge=15V, Tc=125C | | | 2.0 | | |
| Gate Threshold voltage | Ic=4.8mA, Vce=Vge, Tvj=25C | $V_{ge(th)}$ | 5.0 | 5.8 | 6.5 | V |
| Input capacitance | f=1MHz, Tvj=25C, Vce=25V, Vge=0V | C_{ies} | | 21 | | nF |
| Reverse transfer Capacitance | f=1MHz, Tvj=25C, Vce=25V, Vge=0V | C_{res} | | 0.85 | | nF |
| Collector emitter cut off current | Vce=1200V, Vge=0V, Tvj=25C | I_{ces} | | 1 | 5 | mA |
| Gate emitter cut off current | Vce=0V, Vge=20V, Tvj=25C | I_{ges} | | | 400 | nA |



| | | | | |
|--------------------------------|--|--------------------|--------------|----------------------|
| Turn on delay time | Ic=300A, Vcc=600V Vge=+/-15V, Rg=2.4Ω, Tvj=25C Vge=+/-15V, Rg=2.4Ω, Tvj=125C | t _{d,on} | 250 300 | nsec nsec nsec |
| Rise time | Ic=300A, Vcc=600V Vge=+/-15V, Rg=2.4Ω, Tvj=25C Vge=+/-15V, Rg=2.4Ω, Tvj=125C | t _r | 90 100 | nsec nsec nsec |
| Turn off delay time | Ic=300A, Vcc=600V Vge=+/-15V, Rg=2.4Ω, Tvj=25C Vge=+/-15V, Rg=2.4Ω, Tvj=125C | t _{d,off} | 550 650 | nsec nsec nsec |
| Fall time | Ic=300A, Vcc=600V Vge=+/-15V, Rg=2.4Ω, Tvj=25C Vge=+/-15V, Rg=2.4Ω, Tvj=125C | t _f | 130 180 | nsec nsec nsec |
| Turn on energy loss per pulse | Ic=300A, Vce=600V, Vge=+/-15V Rge=2.4Ω, L=30nH Tvj=25C di/dt=6000A/μsec Tvj=125C | E _{on} | 17 25 | mJ mJ |
| Turn off energy loss per pulse | Ic=300A, Vce=600V, Vge=+/-15V Rge=2.4Ω, L=30nH Tvj=25C di/dt=4000A/μsec Tvj=125C | E _{off} | 29.5 44.0 | mJ mJ |
| SC Data | t _p ≤10μsec, Vge≤15V, Vce=900V, Vce(max)=Vces-L di/dt, Tvj=125C | I _{sc} | 1200 | A |
| Stray Module inductance | | L _{σce} | 30 | nH |
| Terminal-chip resistance | | R _c | 1.0 | mΩ |

Diode characteristics

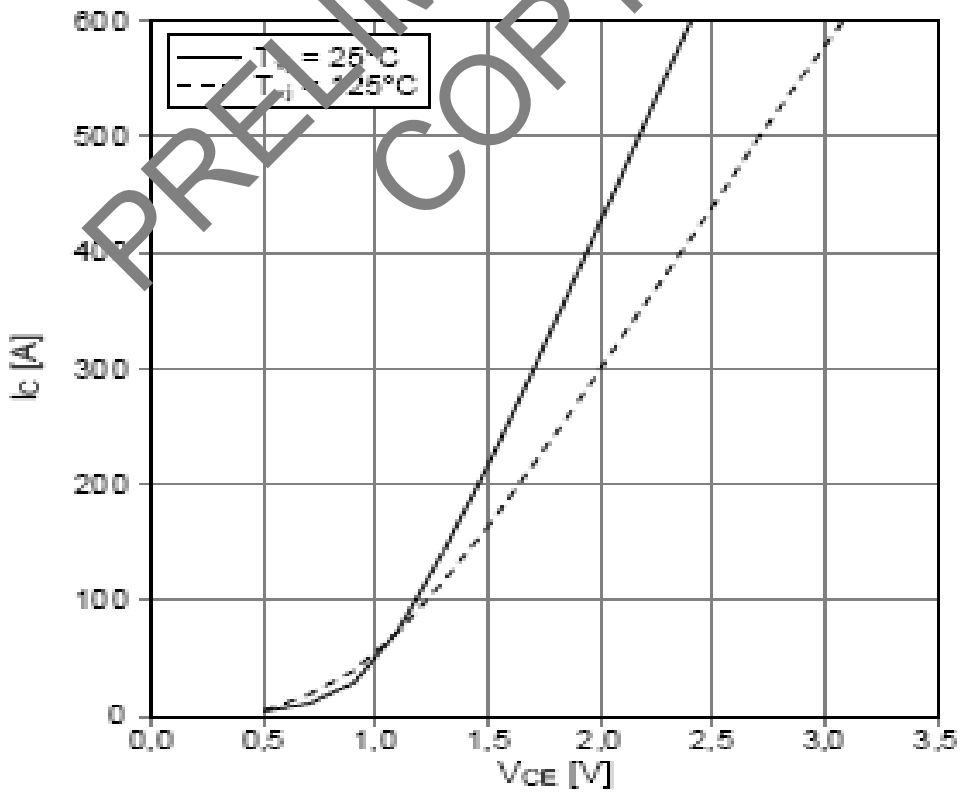
| | | | | |
|-------------------------------|---|------------------|--------------|-----------|
| Forward voltage | Ic=300A, Vge=0V, Tc=25C Ic=300A, Vge=0V, Tc=125C | V _f | 1.65 1.65 | 2.15 V |
| Peak reverse recovery current | If=300A, -di/dt=6000A/μsec Vce=300V, Vge=-15V, Tvj=25C Vce=300V, Vge=-15V, Tvj=125C | I _{rm} | 210 270 | A A |
| Recovered charge | If=300A, -di/dt=6000A/μsec Vce=300V, Vge=-15V, Tvj=25C Vce=300V, Vge=-15V, Tvj=125C | Q _r | 30 56 | μC μC |
| Reverse recovery energy | If=300A, -di/dt=6000A/μsec Vce=300V, Vge=-15V, Tvj=25C Vce=300V, Vge=-15V, Tvj=125C | E _{rec} | 14 26 | mJ mJ |



Thermal Properties

| | | | Min | Typ | Max | |
|-------------------------------------|-------------|-------------------|-----|------|---------------|-----|
| Thermal resistance junction to case | Igibt Diode | $R_{\theta J-C}$ | | | 0.063 0.11 | K/W |
| Thermal resistance case to heatsink | | $R_{\theta C-HS}$ | | 0.03 | | K/W |
| Maximum junction temperature | | T_{vj} | | | 175 | C |
| Maximum operating temperature | | Top | -55 | | 175 | C |
| Storage Temperature | | Tstg | -55 | | 175 | C |

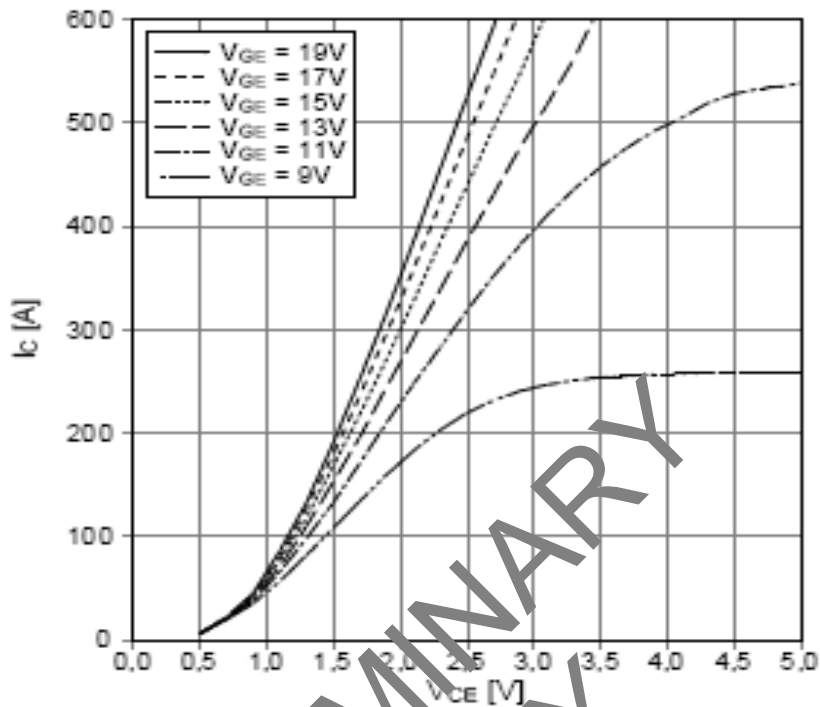
output characteristic IGBT inverter (typical)
 $I_C = f(V_{CE})$
 $V_{GE} = 15\text{ V}$





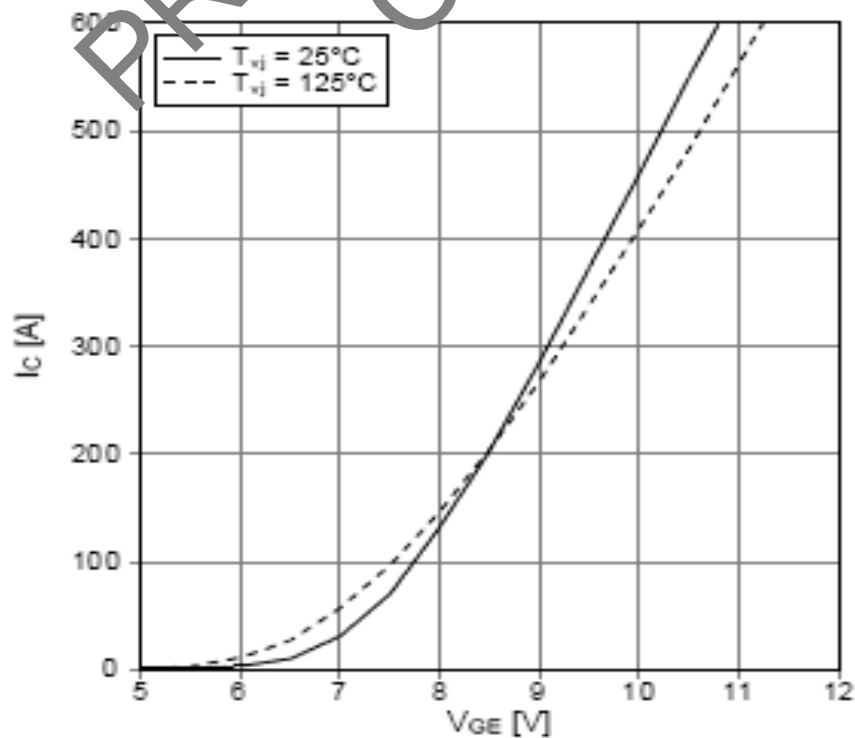
output characteristic IGBT-Inverter (typical)

$I_C = f(V_{CE})$
 $T_{vj} = 125^\circ\text{C}$



transfer characteristic IGBT-inverter (typical)

$I_C = f(V_{GE})$
 $V_{CE} = 20 \text{ V}$

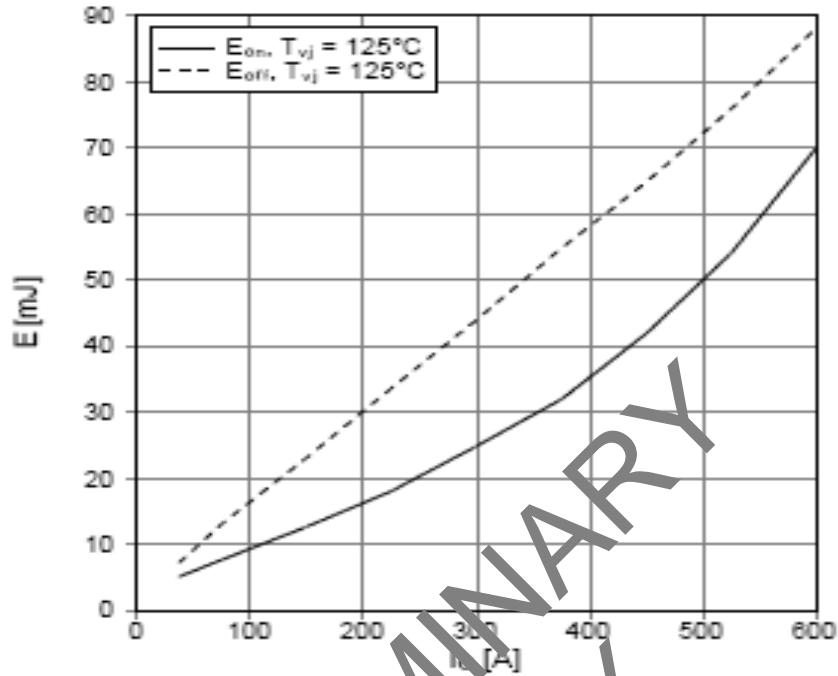




switching losses IGBT-inverter (typical)

$$E_{on} = f(I_c), E_{off} = f(I_c)$$

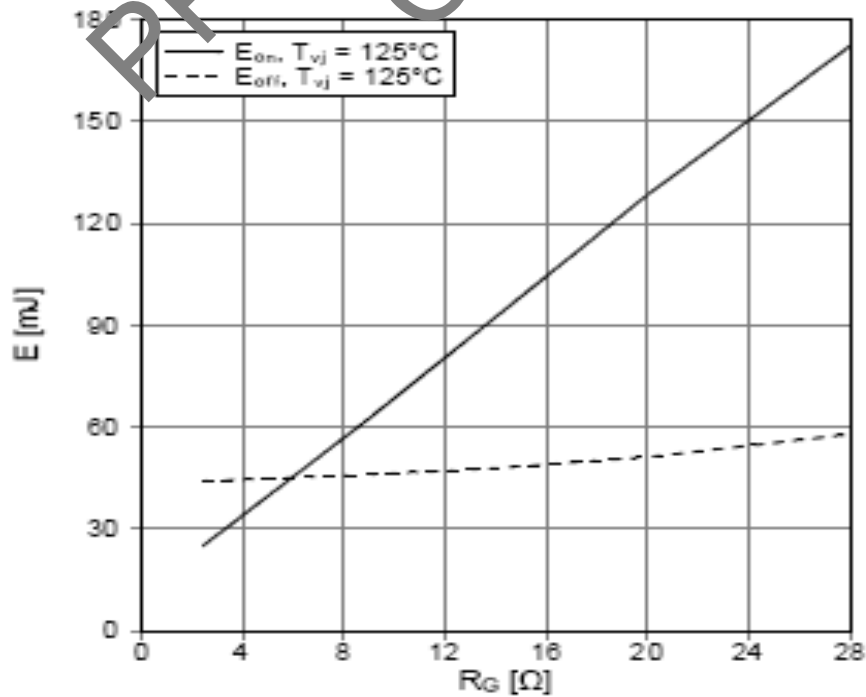
$$V_{GE} = \pm 15 \text{ V}, R_{Gon} = 2.4 \Omega, R_{Goff} = 2.4 \Omega, V_{CE} = 600 \text{ V}$$



switching losses IGBT-Inverter (typical)

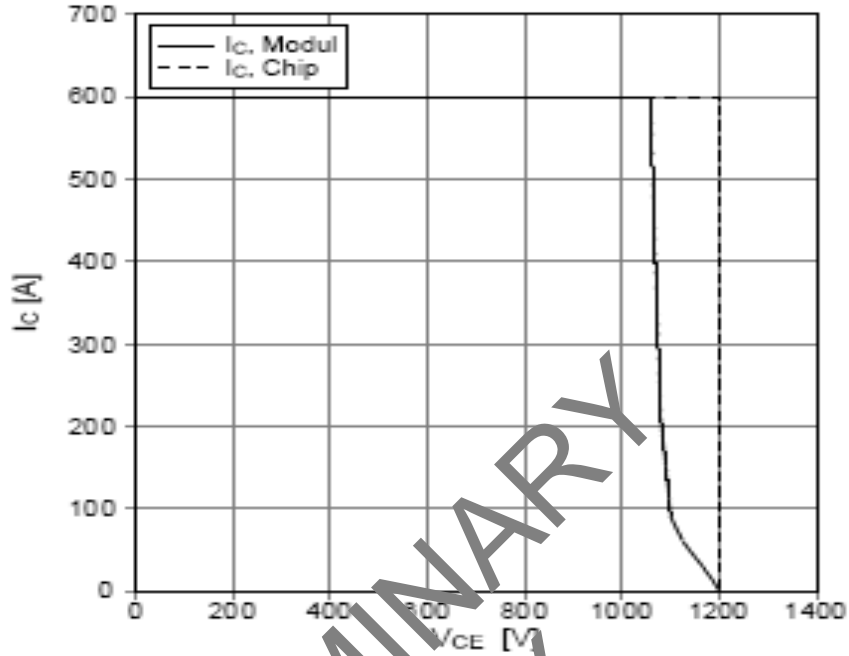
$$E_{on} = f(R_G), E_{off} = f(R_G)$$

$$V_{GE} = \pm 15 \text{ V}, I_c = 300 \text{ A}, V_{CE} = 600 \text{ V}$$

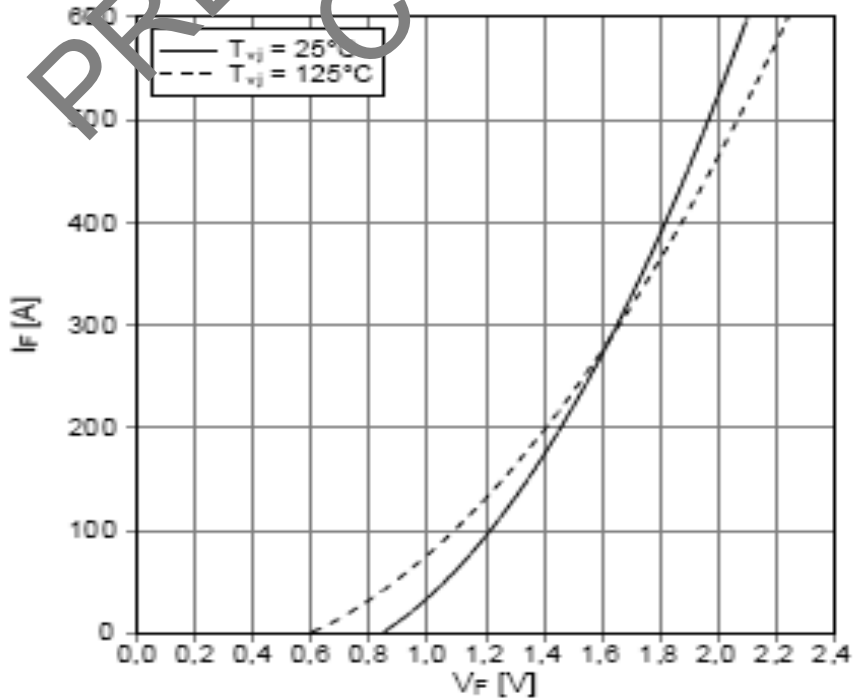


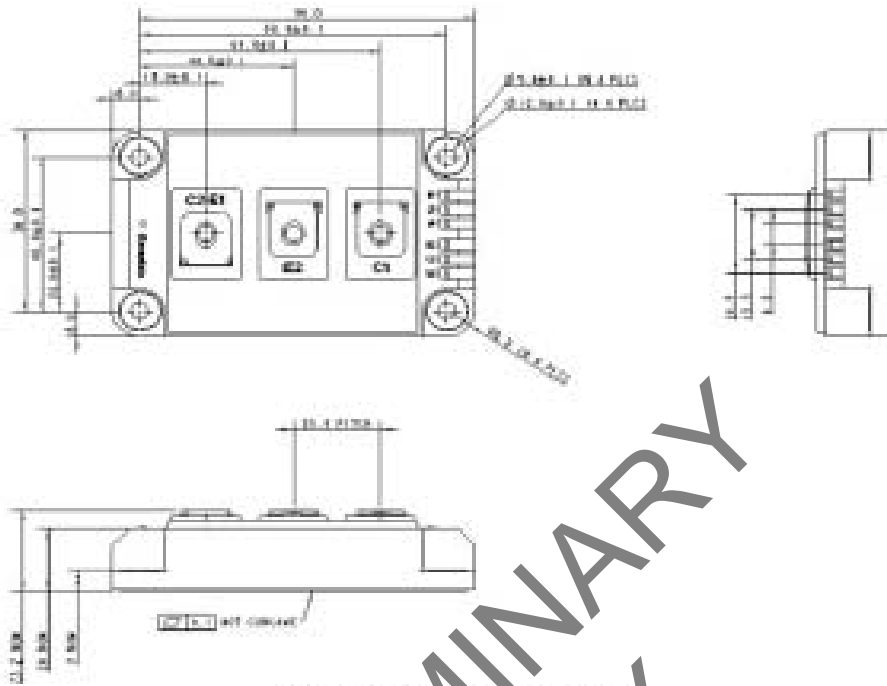


reverse bias safe operating area IGBT-inv. (RBSOA)
 $I_C = f(V_{CE})$
 $V_{GE} = \pm 15\text{ V}$, $R_{Goff} = 2.4\ \Omega$, $T_{vj} = 125^\circ\text{C}$



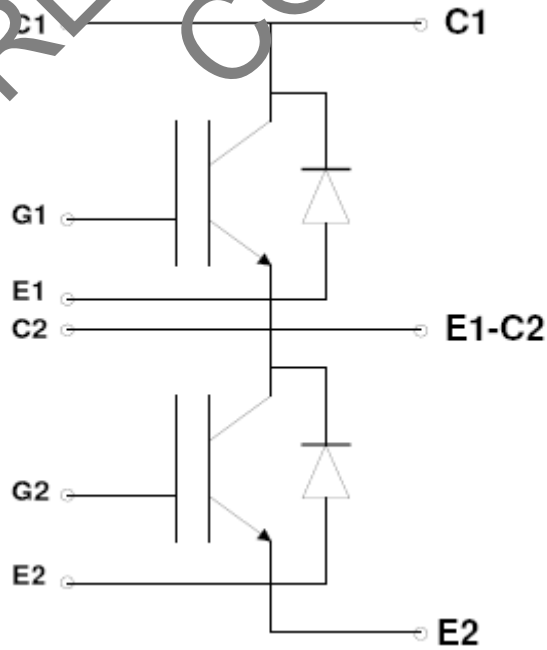
forward characteristic of diode inverter (typical)
 $I_F = f(V_F)$





All dimensions in mm

PRELIMINARY
COPY



CIRCUIT DIAGRAM